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With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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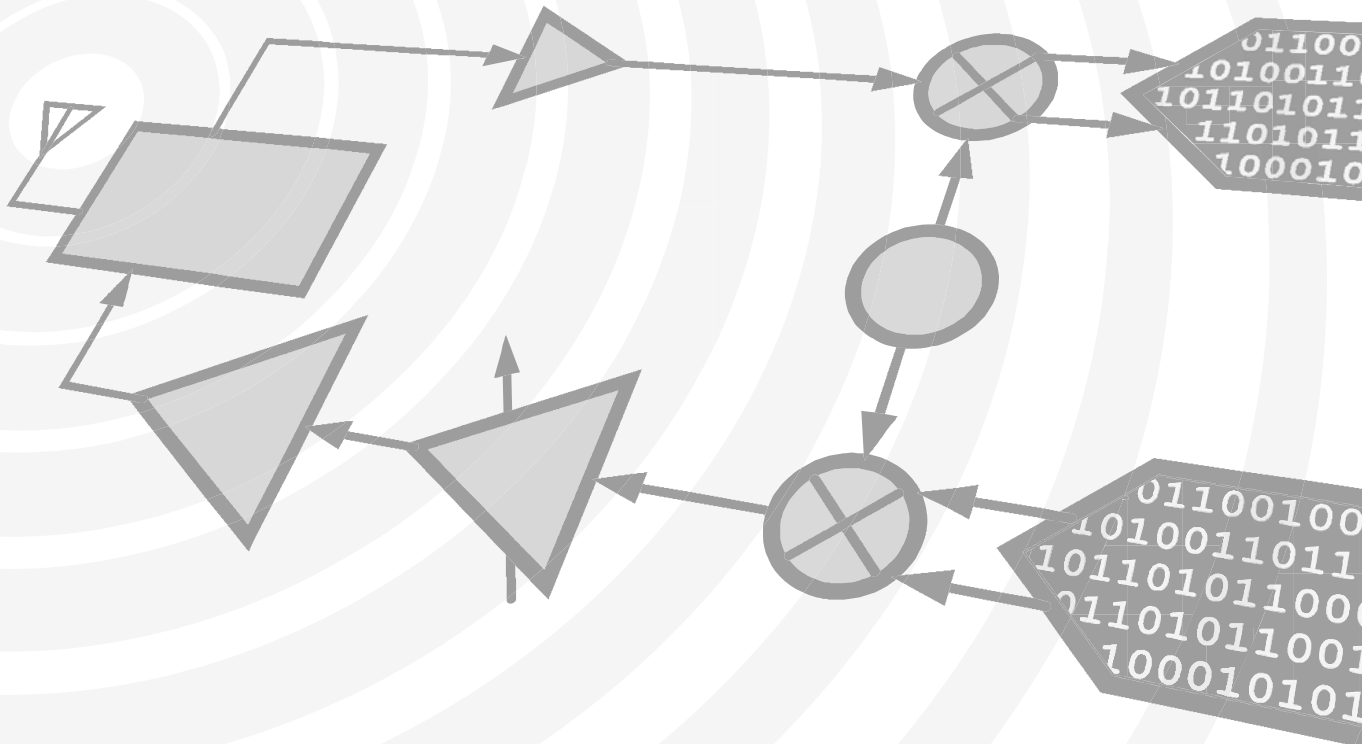
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Analog Devices Welcomes Hittite Microwave Corporation

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HMC272AMS8 / 272AMS8E

GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

Typical Applications

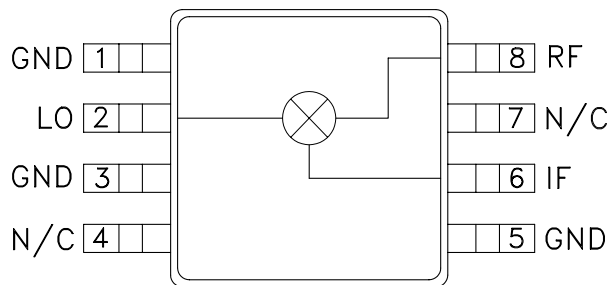
The HMC272AMS8 / HMC272AMS8E is ideal for:

- Up or Down Converter for PCS
- W-CDMA
- 2.4 GHz ISM
- MMDS

Features

- RoHS Compliant Product
- Ultra Small Package: MSOP8
- LO / RF Isolation: 32 dB
- Input IP3: +20 dBm

Functional Diagram



General Description

The HMC272AMS8 & HMC272AMS8E are general purpose ultra miniature single balanced mixers in 8 lead plastic surface mount Mini Small Outline Packages (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and a novel planar transformer balun on the chip. The RF port is balanced via the MMIC balun while the LO port is connected directly to the diodes. The consistent MMIC performance will improve system operation and assure regulatory compliance.

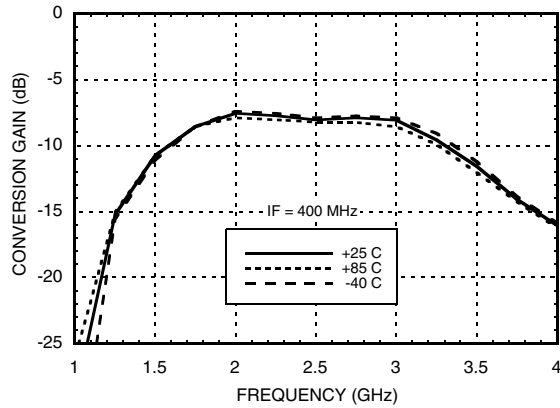
Electrical Specifications, $T_A = +25^\circ C$, As a Function of IF Frequency

Parameter	LO = +10 dBm IF = 100 MHz			LO = +10 dBm IF = 400 MHz			Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF & LO	2 - 3			1.7 - 2.8			GHz
Frequency Range, IF	DC - 0.8			DC - 0.8			GHz
Conversion Loss		9	10.5		9	11	dB
Noise Figure (SSB)		9	10.5		9	11	dB
LO to RF Isolation	22	30		24	32		dB
LO to IF Isolation	12	20		11	18		dB
IP3 (Input)	17	21		16	20		dBm
1 dB Compression (Input)	8	11		7	10		dBm

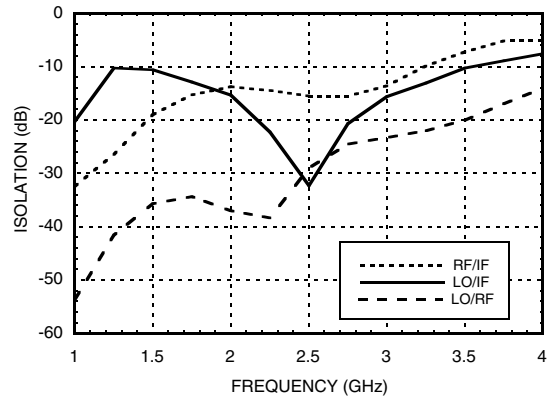


GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

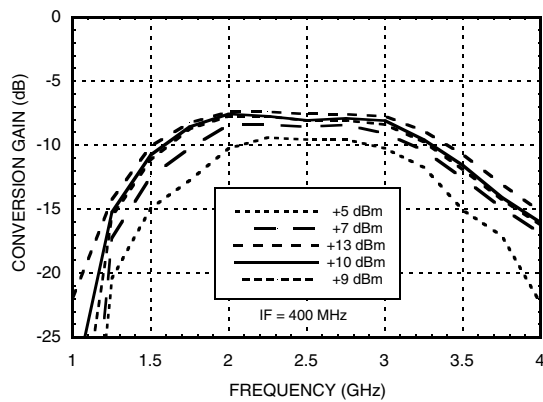
Conversion Gain vs. Temperature @ LO = +10 dBm



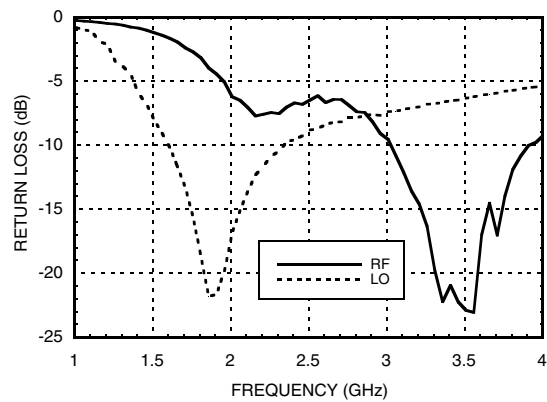
Isolation @ LO = +10 dBm



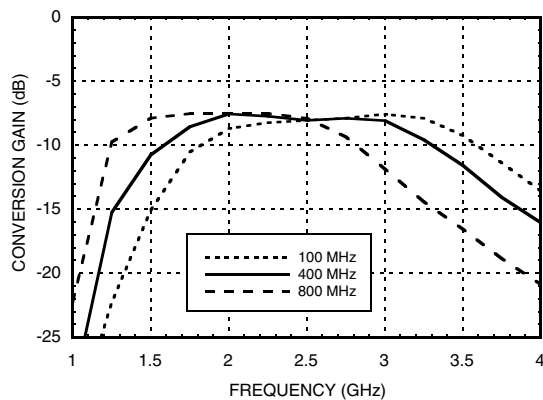
Conversion Gain vs. LO Drive



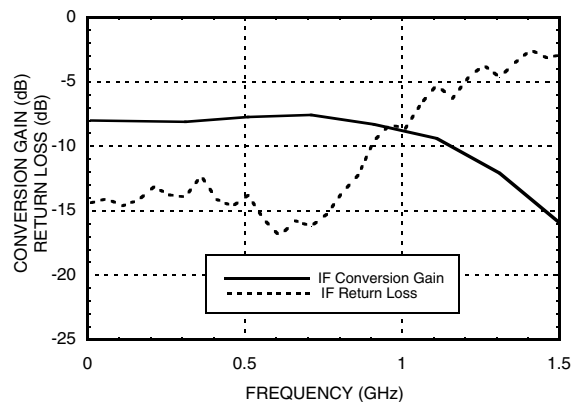
Return Loss @ LO = +10 dBm



Conversion Gain vs. IF Frequency



IF Bandwidth @ LO = +10 dBm vs. Conversion Gain & Return Loss



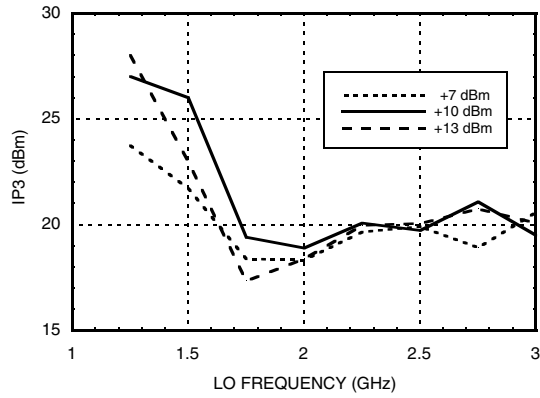
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MIXERS - SINGLE & DOUBLE BALANCED - SMT

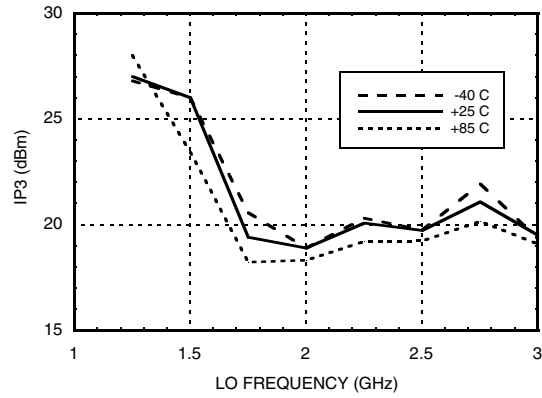


GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

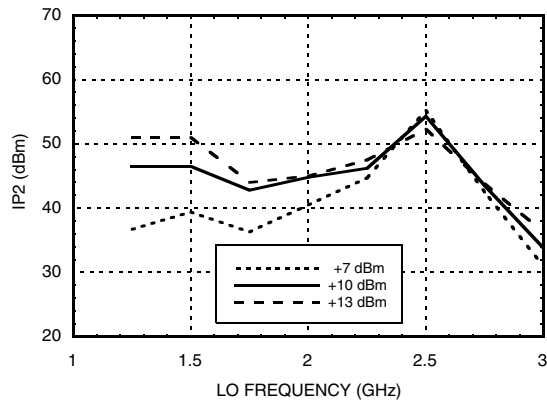
Input IP3 vs. LO Drive



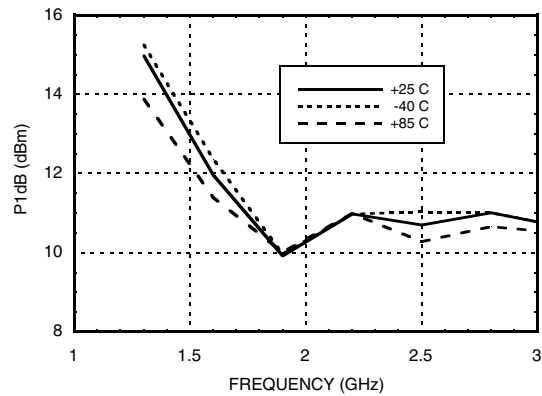
Input IP3 vs. Temperature @ LO = +10 dBm



Input IP2 vs. LO Drive



P1dB vs. Temperature @ LO = +10 dBm





HMC272AMS8 / 272AMS8E

GaAs MMIC SMT SINGLE BALANCED MIXER, 1.7 - 3.0 GHz

MxN Spurious Outputs

mRF	nLO				
	0	1	2	3	4
0	xx	-11	-6	5	19
1	7	0	37	27	38
2	53	64	62	46	72
3	83	>85	>85	>85	>85
4	>85	>85	>85	>85	>85

RF = 2.6 GHz @ -10 dBm
 LO = 2.2 GHz @ +13 dBm
 All values in dBc relative to the IF

Harmonics of LO

LO Frequency (GHz)	nLO Spur at RF Port			
	1	2	3	4
1.5	37	14	36	41
1.7	35	12	37	48
1.9	35	13	43	49
2.1	43	16	42	49
2.3	36	19	37	49
2.5	29	23	36	50

LO = +10 dBm
 Values in dBc below input LO level measured at the RF port.

Absolute Maximum Ratings

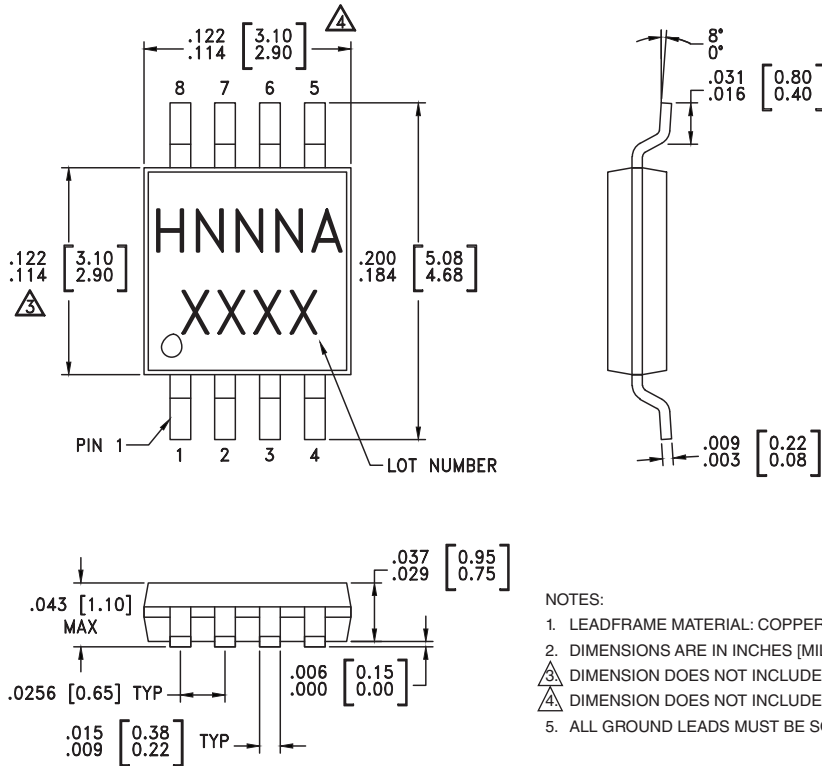
RF / IF Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A





ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

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MIXERS - SINGLE & DOUBLE BALANCED - SMT

Outline Drawing

NOTES:

- LEADFRAME MATERIAL: COPPER ALLOY
- DIMENSIONS ARE IN INCHES [MILLIMETERS].
-  DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
-  DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

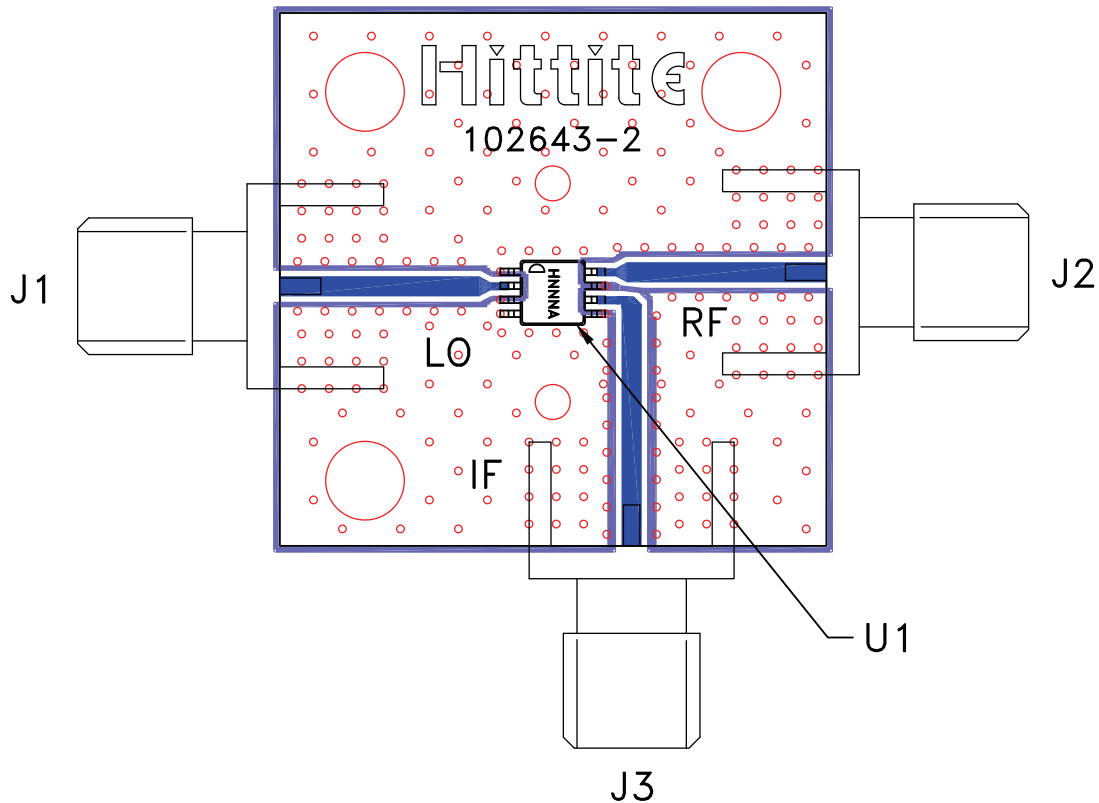
Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC272AMS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H272A XXXX
HMC272AMS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H272A XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

Evaluation Circuit Board

List of Materials for Evaluation PCB 102781 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC272AMS8 / HMC272AMS8E Mixer
PCB [2]	102643 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.